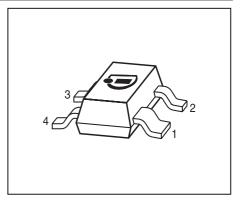


## **BFP183**

### Low Noise Silicon Bipolar RF Transistor

- For low noise, high-gain broadband amplifiers at collector currents from 2 mA to 30 mA
- $f_{\rm T}$  = 8 GHz,  $NF_{\rm min}$  = 0.9 dB at 900 MHz
- Pb-free (RoHS compliant) package
- Qualification report according to AEC-Q101 available





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration					Package	
BFP183	RHs	1=C	2=E	3=B	4=E	-	-	SOT143

#### Maximum Ratings at $T_A$ = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CEO</sub>	12	V
Collector-emitter voltage	V <sub>CES</sub>	20	
Collector-base voltage	V <sub>CBO</sub>	20	
Emitter-base voltage	V <sub>EBO</sub>	2	
Collector current	Ι <sub>C</sub>	65	mA
Base current	I <sub>B</sub>	5	
Total power dissipation <sup>1)</sup>	P <sub>tot</sub>	250	mW
<i>T</i> <sub>S</sub> ≤ 76 °C			
Junction temperature	TJ	150	°C
Storage temperature	T <sub>Stq</sub>	-55 150	

### **Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>2)</sup>	R <sub>thJS</sub>	295	K/W

 ${}^{1}T_{S}$  is measured on the collector lead at the soldering point to the pcb

<sup>2</sup>For the definition of  $R_{\text{thJS}}$  please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics				•	•
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	12	-	-	V
<i>I</i> <sub>C</sub> = 1 mA, <i>I</i> <sub>B</sub> = 0					
Collector-emitter cutoff current	I <sub>CES</sub>	-	-	100	μA
<i>V</i> <sub>CE</sub> = 20 V, <i>V</i> <sub>BE</sub> = 0					
Collector-base cutoff current	I <sub>CBO</sub>	-	-	100	nA
V <sub>CB</sub> = 10 V, <i>I</i> <sub>E</sub> = 0					
Emitter-base cutoff current	I <sub>EBO</sub>	-	-	1	μA
$V_{\rm EB}$ = 1 V, $I_{\rm C}$ = 0					
DC current gain	h <sub>FE</sub>	70	100	140	-
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, pulse measured					

# **Electrical Characteristics** at $T_A$ = 25 °C, unless otherwise specified



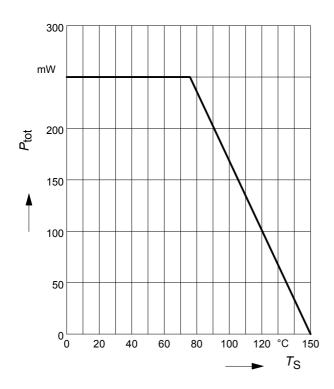
Parameter	Symbol		Values			
		min.	typ.	max.		
AC Characteristics (verified by random samplin	ig)	1		1		
Transition frequency	f <sub>T</sub>	6	8	-	GHz	
<i>I</i> <sub>C</sub> = 25 mA, <i>V</i> <sub>CE</sub> = 8 V, <i>f</i> = 500 MHz						
Collector-base capacitance	C <sub>cb</sub>	-	0.3	0.5	pF	
$V_{\rm CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\rm BE} = 0$ ,						
emitter grounded						
Collector emitter capacitance	C <sub>ce</sub>	-	0.27	-		
$V_{\rm CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\rm BE} = 0$ ,						
base grounded						
Emitter-base capacitance	C <sub>eb</sub>	-	1.1	-	]	
$V_{\rm EB}$ = 0.5 V, f = 1 MHz, $V_{\rm CB}$ = 0 ,						
collector grounded						
Minimum noise figure	NF <sub>min</sub>				dB	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ ,						
<i>f</i> = 900 MHz		-	0.9	-		
<i>f</i> = 1.8 GHz		-	1.4	-		
Power gain, maximum stable <sup>1)</sup>	G <sub>ms</sub>	-	22	-	dB	
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ , $Z_{\rm L}$ = $Z_{\rm Lopt}$ ,						
<i>f</i> = 900 MHz						
Power gain, maximum available <sup>1)</sup>	G <sub>ma</sub>	-	15.5	-	dB	
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ , $Z_{\rm L}$ = $Z_{\rm Lopt}$ ,						
<i>f</i> = 1.8 GHz						
Transducer gain	S <sub>21e</sub>   <sup>2</sup>				dB	
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ ,						
f = 900 MHz		-	17.5	-		
<i>f</i> = 1.8 GHz		-	11.5	-		

## **Electrical Characteristics** at $T_A$ = 25 °C, unless otherwise specified

 ${}^{1}G_{\mathsf{ma}} = |S_{21\mathrm{e}} \ / \ S_{12\mathrm{e}}| \ (\mathsf{k}\text{-}(\mathsf{k}^{2}\text{-}1)^{1/2}), \ G_{\mathsf{ms}} = |S_{21} \ / \ S_{12}|$ 



## Total power dissipation $P_{tot} = f(T_S)$





### Package Outline 1±0.1 2.9 ±0.1 0.15 MIN В 0.1 MAX. 1.9 14 2.4 ±0.15 ±12 0.2 0.08...0.15 A 0.8+0.1 0...8 = 0.2 M A 1.7 Note: Mold flash, protrusions or gate burrs of 0,2 mm max. per side are not included SOT143-PO V09 **Foot Print** 0.8 1.2 0.8 6.0 금 0.8 O 1.2 0.8 SOT143-FPR V09 Marking Layout (Example) Type code 2013, June βX % Cinfineon S Date code (Y M) Manufacturer Pin 1 **Standard Packing** Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel 0.2 $\mathbf{m}$

1.15

SOT143-TP

3.15

Pin 1





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